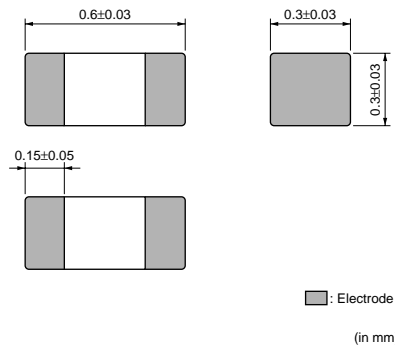


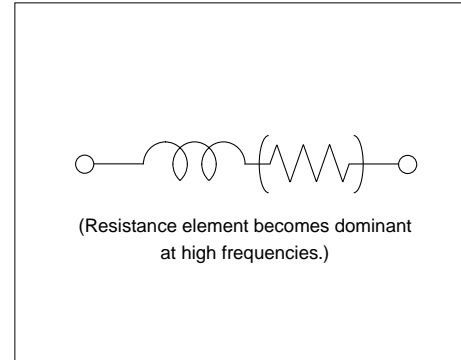
EMIFIL® (Inductor type) Chip Ferrite Bead

BLM03A Series (0201 Size)

■ Dimensions



■ Equivalent Circuit



■ Packaging

Code	Packaging	Minimum Quantity
D	180mm Paper Tape	15000
J	330mm Paper Tape	50000
B	Bulk(Bag)	1000

■ Rated Value (□: packaging code)

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance(max.)	Operating Temperature Range
BLM03AG100SN1 □	10ohm(Typ.)	-	500mA	0.1ohm	-55°C to +125°C
BLM03AG700SN1 □	70ohm(Typ.)	-	200mA	0.4ohm	-55°C to +125°C
BLM03AG800SN1 □	80ohm±25%	-	200mA	0.4ohm	-55°C to +125°C
BLM03AG121SN1 □	120ohm±25%	-	200mA	0.5ohm	-55°C to +125°C
BLM03AG241SN1 □	240ohm±25%	-	200mA	0.8ohm	-55°C to +125°C
BLM03AG601SN1 □	600ohm±25%	-	100mA	1.5ohm	-55°C to +125°C
BLM03AG102SN1 □	1000ohm±25%	-	100mA	2.5ohm	-55°C to +125°C

Number of Circuits: 1

Continued on the following page.

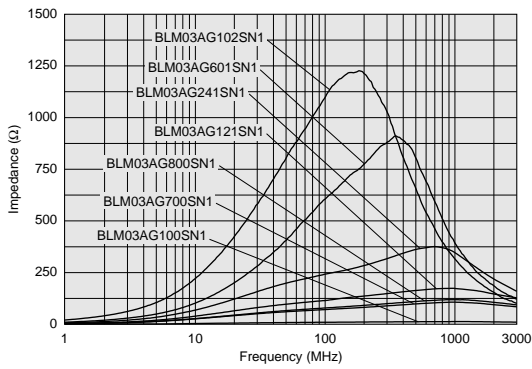
● This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

⚠ Note:

1. This datasheet is downloaded from the website of Murata Manufacturing co., Ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

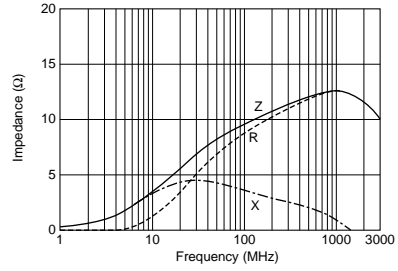
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■ Impedance-Frequency Characteristics (Main Items)



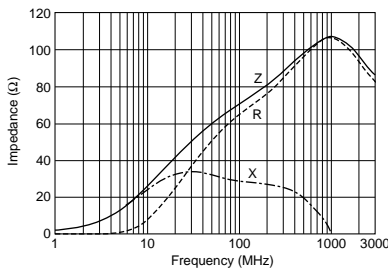
■ Impedance-Frequency Characteristics

BLM03AG100SN1



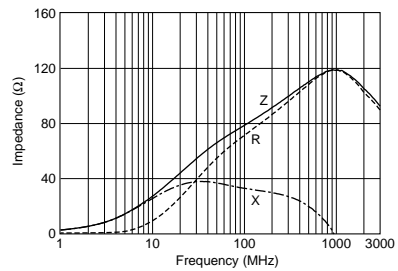
■ Impedance-Frequency Characteristics

BLM03AG700SN1



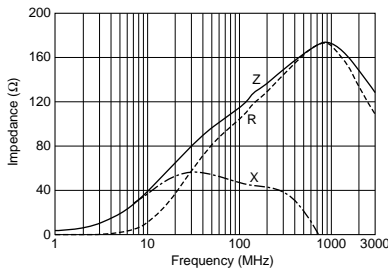
■ Impedance-Frequency Characteristics

BLM03AG800SN1



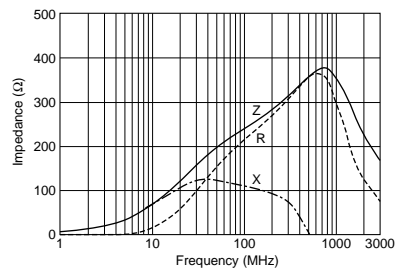
■ Impedance-Frequency Characteristics

BLM03AG121SN1



■ Impedance-Frequency Characteristics

BLM03AG241SN1



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● This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

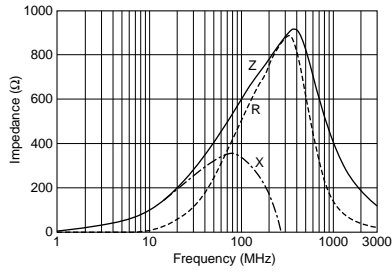
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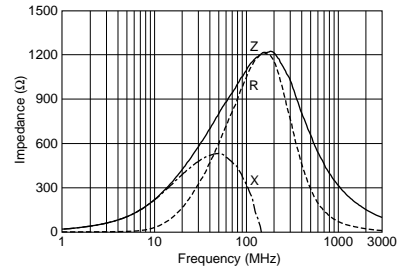
■ Impedance-Frequency Characteristics

BLM03AG601SN1



■ Impedance-Frequency Characteristics

BLM03AG102SN1



■ ⚠ Caution/Notice

⚠ Caution (Rating)

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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